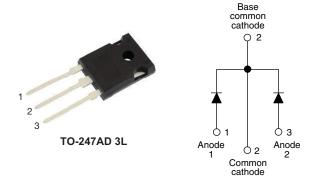


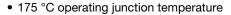
# Hyperfast Soft Recovery Diode, 2 x 30 A FRED Pt<sup>®</sup> Gen 4

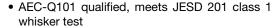


PRODUCT SUMMARY					
Package	TO-247AD 3L				
I <sub>F(AV)</sub>	2 x 30 A				
$V_{R}$	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.37 V				
t <sub>rr</sub> typ.	see Recovery table				
T <sub>J</sub> max.	175 °C				
Diode variation	Common cathode				

#### **FEATURES**

- Gen 4 FRED Pt® technology
- Low I<sub>RRM</sub> and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard











#### ROHS COMPLIANT HALOGEN FREE

#### **DESCRIPTION**

Gen 4 Fred Pt technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Cathode to anode voltage	V <sub>R</sub>		600	V			
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 122 °C	30	۸			
Non-repetitive peak surge current, per leg	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	240	A			
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	YMBOL TEST CONDITIONS		TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	$V_{BR}$ , $V_{R}$	I <sub>R</sub> = 100 μA	600	-	-		
Forward voltage		I <sub>F</sub> = 30 A	-	1.65	2	V	
	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	1.95	-		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	1.44	-		
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	1.78	-		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	1.37	1.6		
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 150 °C	-	1.68	-		
Deviage legises comment	I <sub>R</sub>	V <sub>R</sub> = V <sub>R</sub> rated	-	-	50		
Reverse leakage current		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA	
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	18.3	-	pF	



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST C	TEST CONDITIONS			MAX.	UNITS
Reverse recovery time	+	T <sub>J</sub> = 25 °C	$I_F = 30 \text{ A}$ $dI_F/dt = 1000 \text{ A/}\mu\text{s}$ $V_R = 400 \text{ V}$	1	55	-	ns
	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	75	-	
Dook recovery ourrent	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	13	-	A
Peak recovery current		T <sub>J</sub> = 125 °C		-	23	-	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	500	-	nC
		T <sub>J</sub> = 125 °C		-	1250	-	nC nC

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	1	°C/W	
Thermal resistance, case to heat sink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased	-	0.4	-		
Maiala			-	6.0	-	g	
Weight			-	0.21	-	oz.	
Mounting torque			6.0		12	kgf · cm	
iviounting torque			(5)	_	(20)	(lbf $\cdot$ in)	
Marking device		Case style TO-247AD 3L	C4PH6006LH				

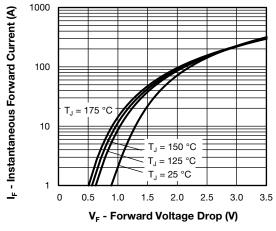


Fig. 1 - Typical Forward Voltage Drop Characteristics

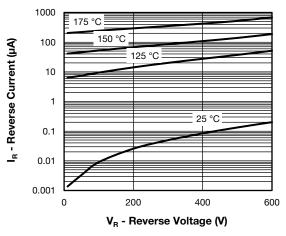


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

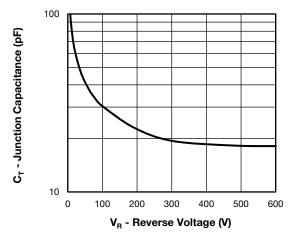


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

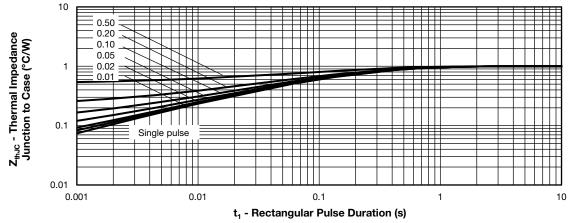


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

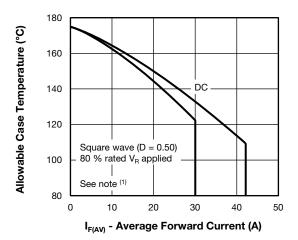


Fig. 5 - Max. Allowable Case Temperature vs.
Average Forward Current

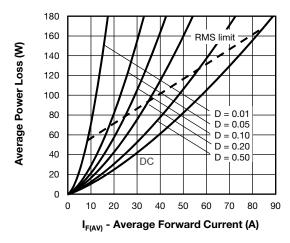


Fig. 6 - Forward Power Loss Characteristics

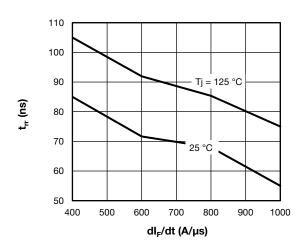


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_{\text{F}}/dt$ 

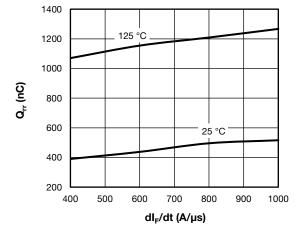


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

 $\begin{array}{l} \text{(1)} \ \ \text{Formula used: } T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \ \text{at } (I_{F(AV)}/D) \ \text{(see Fig. 5)} \\ P_{dREV} = \text{inverse power loss} = V_{R1} \times I_R \ \text{(1 - D); } I_R \ \text{at } V_R = \text{rated } V_R \\ \end{array}$ 

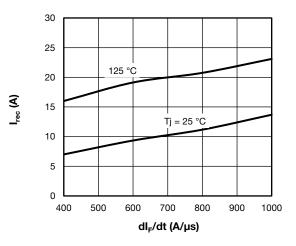


Fig. 9 - Typical Reverse Current vs. dl<sub>F</sub>/dt

#### **ORDERING INFORMATION TABLE**

Device code VS-C Ρ Н 60 Н **N3** 4 06 L (2) (4) (5) (6) (7) 9 (10)(3) (8) Vishay Semiconductors product Circuit configuration: C = common cathode FRED Gen 4 P = TO-247 package Process type: H = hyperfast recovery Current rating (60 = 60 A) Voltage rating (06 = 600 V) L = long lead H = AEC-Q101 qualified Environmental digit:

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-C4PH6006LHN3	25	500	Antistatic plastic tube			

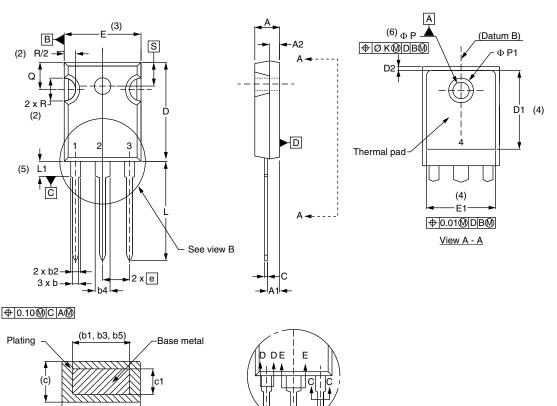
N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions	TO-247AD 3L	www.vishay.com/doc?95626			
Part marking information	TO-247AD 3L	www.vishay.com/doc?95007			



### **TO-247AD 3L**

#### **DIMENSIONS** in millimeters and inches



View B

0)/14001	MILLIN	IETERS	INC	NOTES	
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

Section C - C, D - D, E - E

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
OTIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	0.215 BSC	
ØК	0.2	0.254		0.010	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	
		•	•		

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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